Electronic Patent Application Fee Transmittal							
Application Number:	10576639						
Filing Date:	26-Dec-2006						
Title of Invention:	METHOD FOR GLUING A CIRCUIT COMPONENT TO A CIRCUIT SUBSTRATE						
First Named Inventor/Applicant Name:	Willbald Konrath						
Filer:	David E. Bennett/Alfonso G. Sandoval						
Attorney Docket Number:	4015-5820						
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Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
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